

Title (en)

METHOD FOR PRODUCING AN ORGANIC OPTOELECTRONIC COMPONENT AND ORGANIC OPTOELECTRONIC COMPONENT

Title (de)

VERFAHREN ZUR HERSTELLUNG EINES ORGANISCHEN OPTOELEKTRONISCHEN BAUELEMENTS UND ORGANISCHES OPTOELEKTRONISCHES BAUELEMENT

Title (fr)

PROCÉDÉ POUR FABRIQUER UN COMPOSANT OPTOÉLECTRONIQUE ORGANIQUE ET COMPOSANT OPTOÉLECTRONIQUE ORGANIQUE

Publication

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Application

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Abstract (en)

[origin: WO2010079038A1] The invention relates to the production of an organic optoelectronic component comprising the following steps: A) providing a first substrate (1) having an active region (12) and a first connection region (11) surrounding said active region (12), wherein an organic, functional layer sequence (3) is formed in said active region (12), B) providing a second substrate (2) having a cover region (22) and a second connection region (21) surrounding said cover region (22), C) applying a first connection layer (4) made from a first glass solder material directly to said second substrate (2) in said second connection region (21), D) glazing (91) said first glass solder material of said first connection layer (4), E) applying a second connection layer (5) to said glazed first connection layer (4) or to said first connection region (11) of said first substrate (1) and F) connecting said first substrate (1) to said second substrate (2) such that said second connection layer (5) connects said first connection region (11) to said first connection layer (4). The invention furthermore relates to an organic optoelectronic component.

IPC 8 full level

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